

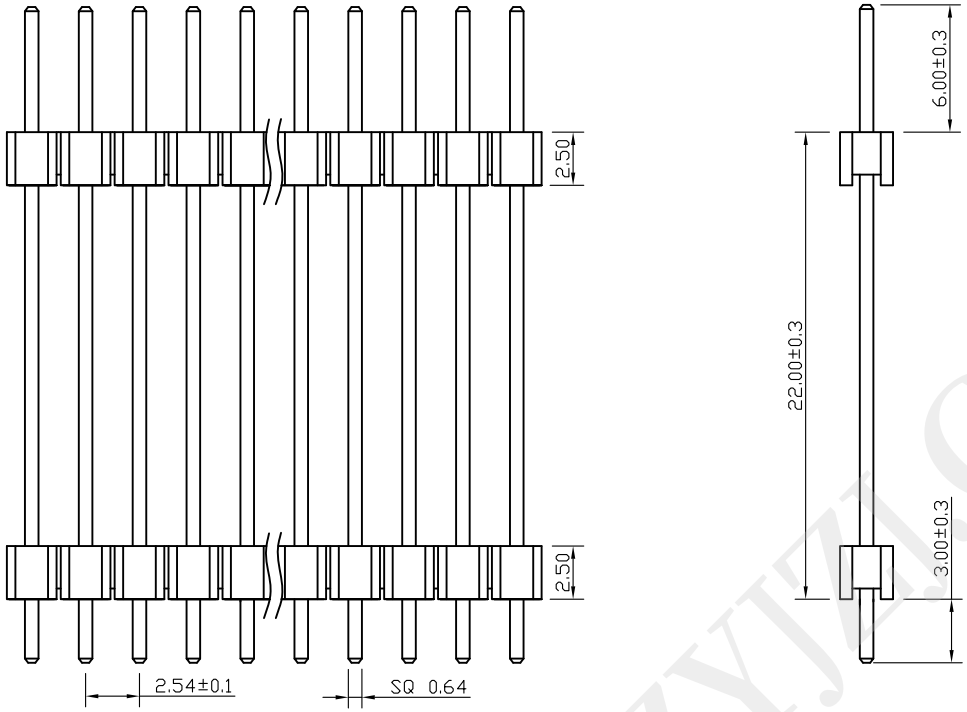

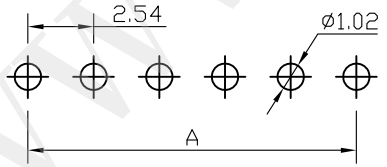

RECOMMEND P.C.B LAYOUT

PCB TOLERANCE:±0.05 (TOP VIEW)

No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B
1	0.00	2.54	11	25.40	27.94	21	50.80	53.34	31	76.20	78.74
2	2.54	5.08	12	27.94	30.48	22	53.34	55.88	32	78.74	81.28
3	5.08	7.62	13	30.48	33.02	23	55.88	58.42	33	81.28	83.82
4	7.62	10.16	14	33.02	35.56	24	58.42	60.96	34	83.82	86.36
5	10.16	12.70	15	35.56	38.10	25	60.96	63.50	35	86.36	88.90
6	12.70	15.24	16	38.10	40.64	26	63.50	66.04	36	88.90	91.44
7	15.24	17.78	17	40.64	43.18	27	66.04	68.58	37	91.44	93.98
8	17.78	20.32	18	43.18	45.72	28	68.58	71.12	38	93.98	96.52
9	20.32	22.86	19	45.72	48.26	29	71.12	73.66	39	96.52	99.06
10	22.86	25.40	20	48.26	50.80	30	73.66	76.20	40	99.06	101.60

SPECIFICATIONS

Current Rating:	3Amps
Insulation Resistance:	1000MΩ Min
Contact Resistance:	20mΩ Max
Withstanding Voltage:	AC 1000V
Operation Temperature:	-40° to+105°
Contact Material:	Brass
Standard:	PA6T
Insrlator Material:	Polyester(UL 94V-0)
Contact Plating:	Gold Flash
Max.Processing Temp:	240° C for30-60seconds (260° C for5seconds)

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME:2.54PH H2.5双塑 1xnPin 180度 PC3.0 PA6.0 PB22.0 L31.0
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCO-50M254-1XX-3100
UNIT: mm [inch]			MOLD NO.
	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2506261117
SCALE:1:1 SIZE: A4			SHEET NO. 1 OF 1

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